

EconoPIM™3 module with fast Trench/Fieldstop IGBT4 and emitter controlled 4 diode and PressFIT / NTC

Features

- Electrical features
 - $V_{CES} = 1200\text{ V}$
 - $I_{C\text{ nom}} = 75\text{ A} / I_{CRM} = 150\text{ A}$
 - Low switching losses
 - Low $V_{CE,\text{sat}}$
 - $T_{vj,\text{op}} = 150^\circ\text{C}$
 - $V_{CE,\text{sat}}$ with positive temperature coefficient
- Mechanical features
 - PressFIT contact technology
 - Standard housing
 - Integrated NTC temperature sensor
 - High power and thermal cycling capability
 - Copper base plate



Typical appearance

Potential applications

- Auxiliary inverters
- Motor drives
- Servo drives

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

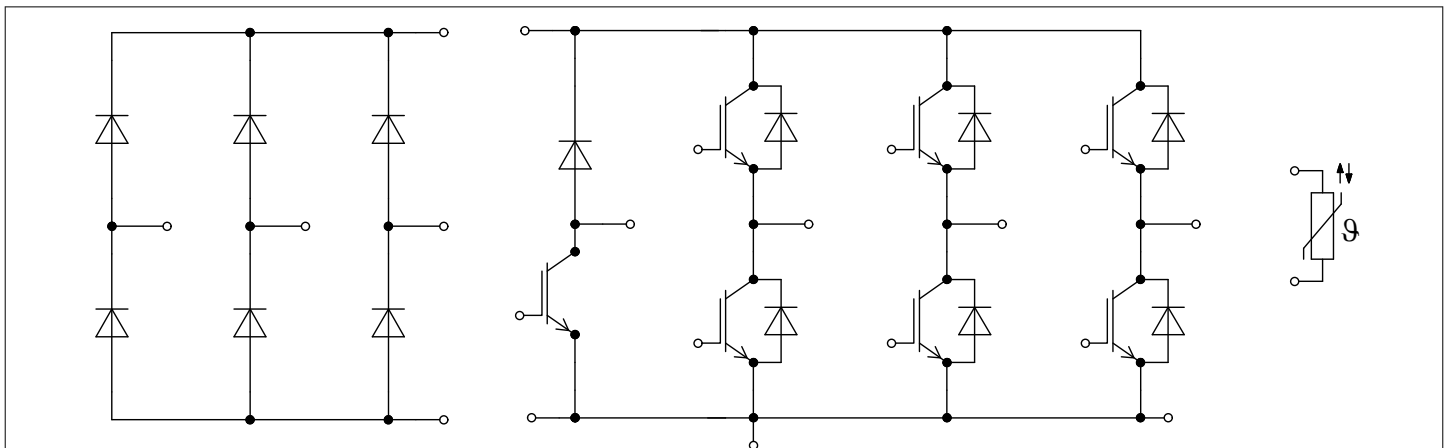


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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	10.0	mm
Clearance	d_{Clear}	terminal to heatsink	7.5	mm
Comparative tracking index	CTI		> 200	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{SCE}			40		nH
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_C = 25^\circ\text{C}$, per switch		3		mΩ
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25^\circ\text{C}$, per switch		4		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting torque for module mounting	M	- Mounting according to valid application note		3	6	Nm
Weight	G			300		g

Note: for operation with $V_{ge} = 0V/+15V$ we recommend a $R_{gon, min}$ of 2,2 ohms and a $R_{goff, min}$ of 2,2 ohms (see AN 2006-01)

The current under continuous operation is limited to 50 A rms per connector pin.

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25^\circ\text{C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj max} = 175^\circ\text{C}$ $T_C = 95^\circ\text{C}$	75	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj op}$	150	A

(table continues...)

Table 3 (continued) Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Gate-emitter peak voltage	V_{GES}		±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 75\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$	1.85	2.15	V
			$T_{vj} = 125\ ^\circ C$	2.15		
			$T_{vj} = 150\ ^\circ C$	2.25		
Gate threshold voltage	V_{GETh}	$I_C = 2.4\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$	5.20	5.80	6.40	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V$		0.57		µC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$		10		Ω
Input capacitance	C_{ies}	$f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$		4.3		nF
Reverse transfer capacitance	C_{res}	$f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$		0.16		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$		1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 75\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1.1\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.160		µs
			$T_{vj} = 125\ ^\circ C$	0.170		
			$T_{vj} = 150\ ^\circ C$	0.170		
Rise time (inductive load)	t_r	$I_C = 75\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1.1\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.030		µs
			$T_{vj} = 125\ ^\circ C$	0.040		
			$T_{vj} = 150\ ^\circ C$	0.040		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 75\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1.1\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.340		µs
			$T_{vj} = 125\ ^\circ C$	0.430		
			$T_{vj} = 150\ ^\circ C$	0.450		
Fall time (inductive load)	t_f	$I_C = 75\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1.1\ \Omega$	$T_{vj} = 25\ ^\circ C$	0.080		µs
			$T_{vj} = 125\ ^\circ C$	0.150		
			$T_{vj} = 150\ ^\circ C$	0.170		
Turn-on energy loss per pulse	E_{on}	$I_C = 75\ A, V_{CC} = 600\ V, L_\sigma = 40\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 1.1\ \Omega, di/dt = 2500\ A/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$	3.1		mJ
			$T_{vj} = 125\ ^\circ C$	6.6		
			$T_{vj} = 150\ ^\circ C$	7.65		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy loss per pulse	E_{off}	$I_C = 75\text{ A}$, $V_{CC} = 600\text{ V}$, $L_\sigma = 40\text{ nH}$, $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 1.1\ \Omega$, $dv/dt = 3600\text{ V}/\mu\text{s}$ ($T_{vj} = 150\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	4.2		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	6.4		
			$T_{vj} = 150\text{ }^\circ\text{C}$	7.2		
SC data	I_{SC}	$V_{GE} \leq 15\text{ V}$, $V_{CC} = 800\text{ V}$, $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$t_p \leq 10\ \mu\text{s}$, $T_{vj} = 150\text{ }^\circ\text{C}$	270		A
Thermal resistance, junction to case	R_{thJC}	per IGBT			0.390	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.130		K/W
Temperature under switching conditions	T_{vjop}		-40		150	$^\circ\text{C}$

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25\text{ }^\circ\text{C}$	1200	V	
Continuous DC forward current	I_F		75	A	
Repetitive peak forward current	I_{FRM}	$t_p = 1\text{ ms}$	150	A	
I^2t - value	I^2t	$t_p = 10\text{ ms}$, $V_R = 0\text{ V}$	$T_{vj} = 125\text{ }^\circ\text{C}$	960	A^2s

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 75\text{ A}$, $V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ }^\circ\text{C}$	1.70	2.15	V
			$T_{vj} = 125\text{ }^\circ\text{C}$	1.65		
			$T_{vj} = 150\text{ }^\circ\text{C}$	1.65		
Peak reverse recovery current	I_{RM}	$V_{CC} = 600\text{ V}$, $I_F = 75\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 2500\text{ A}/\mu\text{s}$ ($T_{vj} = 150\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	88		A
			$T_{vj} = 125\text{ }^\circ\text{C}$	89		
			$T_{vj} = 150\text{ }^\circ\text{C}$	90		
Recovered charge	Q_r	$V_{CC} = 600\text{ V}$, $I_F = 75\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 2500\text{ A}/\mu\text{s}$ ($T_{vj} = 150\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	7.3		μC
			$T_{vj} = 125\text{ }^\circ\text{C}$	13		
			$T_{vj} = 150\text{ }^\circ\text{C}$	14.5		

(table continues...)

Table 6 (continued) **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Reverse recovery energy	E_{rec}	$V_{CC} = 600\text{ V}$, $I_F = 75\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 2500\text{ A}/\mu\text{s}$ ($T_{vj} = 150\text{ °C}$)	$T_{vj} = 25\text{ °C}$	2.65		mJ
			$T_{vj} = 125\text{ °C}$	4.6		
			$T_{vj} = 150\text{ °C}$	5.65		
Thermal resistance, junction to case	R_{thJC}	per diode			0.620	K/W
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.205		K/W
Temperature under switching conditions	$T_{vj,op}$		-40		150	°C

4 Diode, Rectifier

Table 7 **Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25\text{ °C}$	1600	V	
Maximum RMS forward current per chip	I_{FRMSM}	$T_C = 80\text{ °C}$	80	A	
Maximum RMS current at rectifier output	I_{RMSM}	$T_C = 80\text{ °C}$	140	A	
Surge forward current	I_{FSM}	$t_p = 10\text{ ms}$	$T_{vj} = 25\text{ °C}$	600	A
			$T_{vj} = 150\text{ °C}$	470	
I^2t - value	I^2t	$t_p = 10\text{ ms}$	$T_{vj} = 25\text{ °C}$	1800	A ² s
			$T_{vj} = 150\text{ °C}$	1100	

Table 8 **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 75\text{ A}$, $T_{vj} = 150\text{ °C}$		1.15		V
Reverse current	I_r	$T_{vj} = 150\text{ °C}$, $V_R = 1600\text{ V}$		1		mA
Thermal resistance, junction to case	R_{thJC}	per diode			0.650	K/W
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.215		K/W
Temperature under switching conditions	$T_{vj,op}$		-40		150	°C

5 IGBT, Brake-Chopper

Table 9 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25\text{ °C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj\text{ max}} = 175\text{ °C}$ $T_C = 95\text{ °C}$	50	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\text{ op}}$	100	A
Gate-emitter peak voltage	V_{GES}		± 20	V

Table 10 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 50\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.85	2.15	V
			$T_{vj} = 125\text{ °C}$	2.15		
			$T_{vj} = 150\text{ °C}$	2.25		
Gate threshold voltage	V_{GETh}	$I_C = 1.6\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25\text{ °C}$	5.20	5.80	6.40	V
Gate charge	Q_G	$V_{GE} = \pm 15\text{ V}$		0.38		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\text{ °C}$		4		Ω
Input capacitance	C_{ies}	$f = 1000\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		2.8		nF
Reverse transfer capacitance	C_{res}	$f = 1000\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		0.1		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}$ $T_{vj} = 25\text{ °C}$			1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25\text{ °C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 15\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.160		μs
			$T_{vj} = 125\text{ °C}$	0.170		
			$T_{vj} = 150\text{ °C}$	0.170		
Rise time (inductive load)	t_r	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 15\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.030		μs
			$T_{vj} = 125\text{ °C}$	0.040		
			$T_{vj} = 150\text{ °C}$	0.040		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 15\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.330		μs
			$T_{vj} = 125\text{ °C}$	0.430		
			$T_{vj} = 150\text{ °C}$	0.450		

(table continues...)

Table 10 (continued) **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Fall time (inductive load)	t_f	$I_C = 50 \text{ A}, V_{CC} = 600 \text{ V},$ $V_{GE} = \pm 15 \text{ V}, R_{Goff} = 15 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	0.080		μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$	0.150		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	0.170		
Turn-on energy loss per pulse	E_{on}	$I_C = 50 \text{ A}, V_{CC} = 600 \text{ V},$ $L_\sigma = 20 \text{ nH}, V_{GE} = \pm 15 \text{ V},$ $R_{Gon} = 15 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	5.7		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	7.7		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	8.4		
Turn-off energy loss per pulse	E_{off}	$I_C = 50 \text{ A}, V_{CC} = 600 \text{ V},$ $L_\sigma = 20 \text{ nH}, V_{GE} = \pm 15 \text{ V},$ $R_{Goff} = 15 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	2.8		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	4.3		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	4.8		
SC data	I_{SC}	$V_{GE} \leq 15 \text{ V}, V_{CC} = 800 \text{ V},$ $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$t_p \leq 10 \mu\text{s},$ $T_{vj} = 150 \text{ }^\circ\text{C}$	180		A
Thermal resistance, junction to case	R_{thJC}	per IGBT			0.540	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$		0.245		K/W
Temperature under switching conditions	$T_{vj op}$		-40		150	$^\circ\text{C}$

6 Diode, Brake-Chopper

Table 11 **Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25 \text{ }^\circ\text{C}$	1200	V	
Continuous DC forward current	I_F		25	A	
Repetitive peak forward current	I_{FRM}	$t_p = 1 \text{ ms}$	50	A	
I^2t - value	I^2t	$t_p = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	90	A^2s
			$T_{vj} = 150 \text{ }^\circ\text{C}$	80	

Table 12 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	V_F	$I_F = 25 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		1.75	2.15	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$		1.75		
			$T_{vj} = 150 \text{ }^\circ\text{C}$		1.75		
Peak reverse recovery current	I_{RM}	$V_{CC} = 600 \text{ V}, I_F = 25 \text{ A}, -di_F/dt = 1200 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		39		A
			$T_{vj} = 125 \text{ }^\circ\text{C}$		40		
			$T_{vj} = 150 \text{ }^\circ\text{C}$		41		
Recovered charge	Q_r	$V_{CC} = 600 \text{ V}, I_F = 25 \text{ A}, -di_F/dt = 1200 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		2.4		μC
			$T_{vj} = 125 \text{ }^\circ\text{C}$		4.1		
			$T_{vj} = 150 \text{ }^\circ\text{C}$		4.4		
Reverse recovery energy	E_{rec}	$V_{CC} = 600 \text{ V}, I_F = 25 \text{ A}, -di_F/dt = 1200 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.9		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		1.5		
			$T_{vj} = 150 \text{ }^\circ\text{C}$		1.7		
Thermal resistance, junction to case	R_{thJC}	per diode			1.35	K/W	
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$		0.610		K/W	
Temperature under switching conditions	$T_{vj op}$		-40		150	$^\circ\text{C}$	

7 NTC-Thermistor

Table 13 Characteristic values

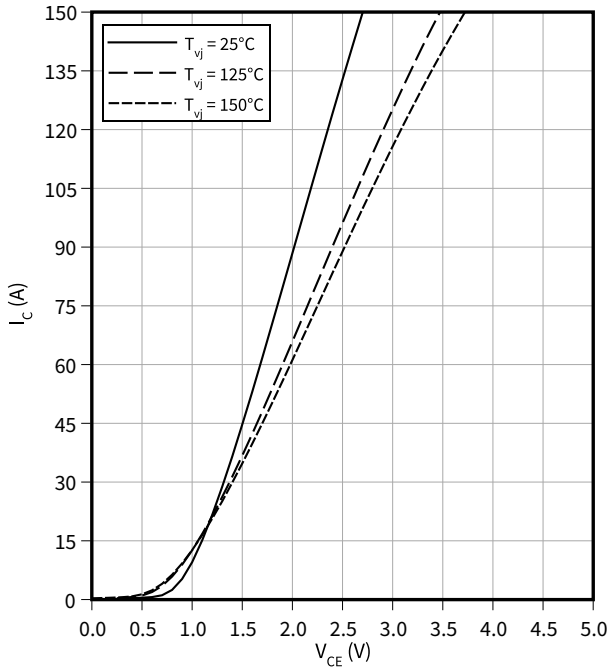
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$		5		k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ }^\circ\text{C}, R_{100} = 493 \text{ } \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

Note: Specification according to the valid application note.

8 Characteristics diagrams

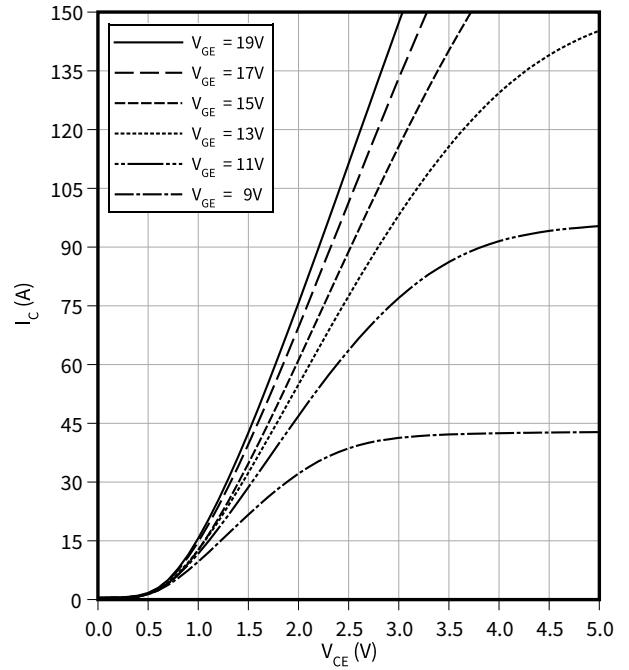
Output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



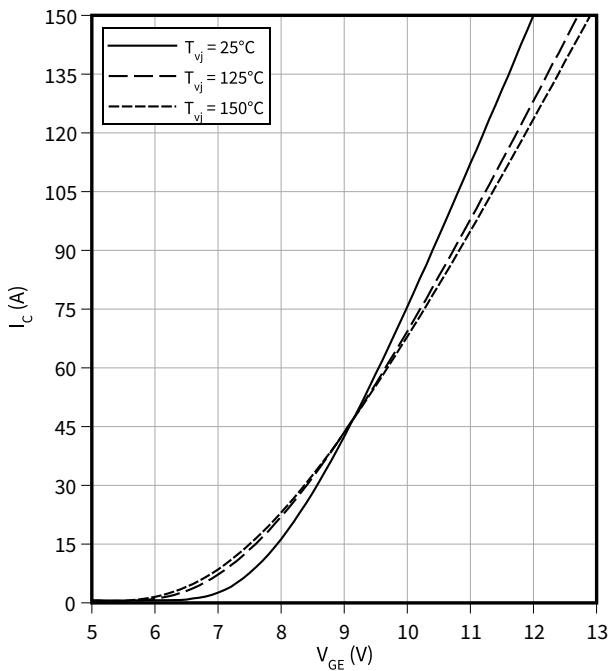
Output characteristic field (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $T_{vj} = 150\text{ °C}$



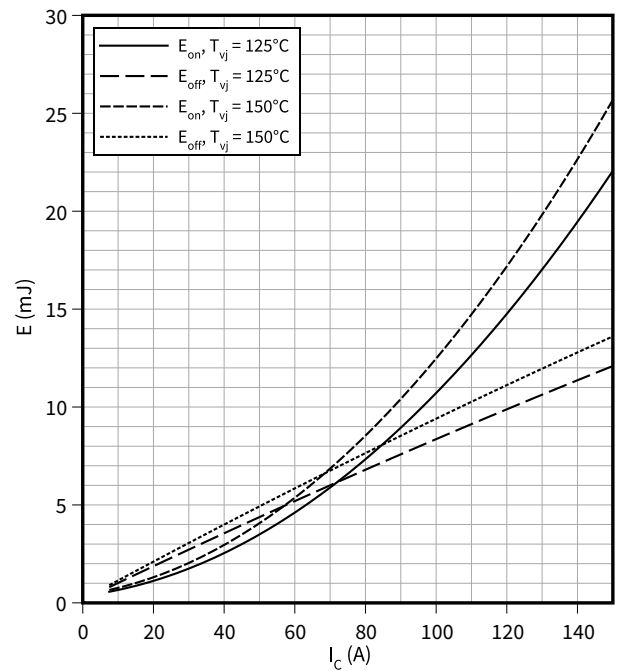
Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



Switching losses (typical), IGBT, Inverter

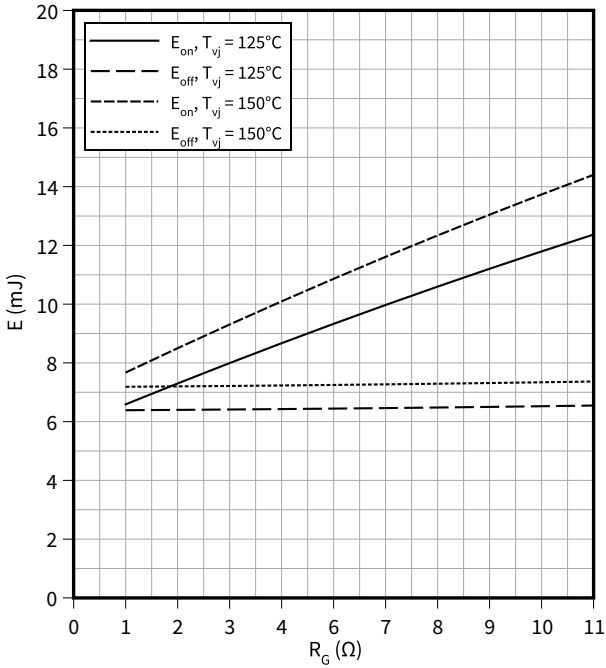
$E = f(I_C)$
 $R_{Goff} = 1.1\ \Omega, R_{Gon} = 1.1\ \Omega, V_{GE} = \pm 15\text{ V}, V_{CC} = 600\text{ V}$



Switching losses (typical), IGBT, Inverter

$E = f(R_G)$

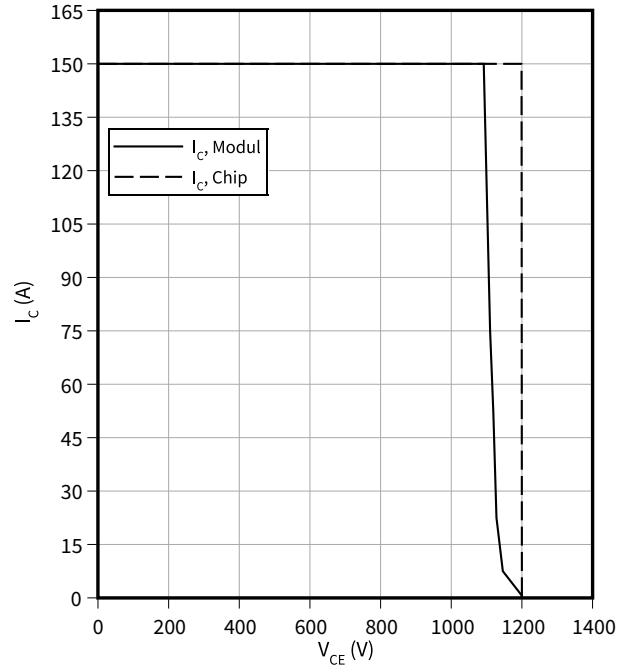
$V_{GE} = \pm 15 \text{ V}$, $I_C = 75 \text{ A}$, $V_{CC} = 600 \text{ V}$



Reverse bias safe operating area (RBSOA), IGBT, Inverter

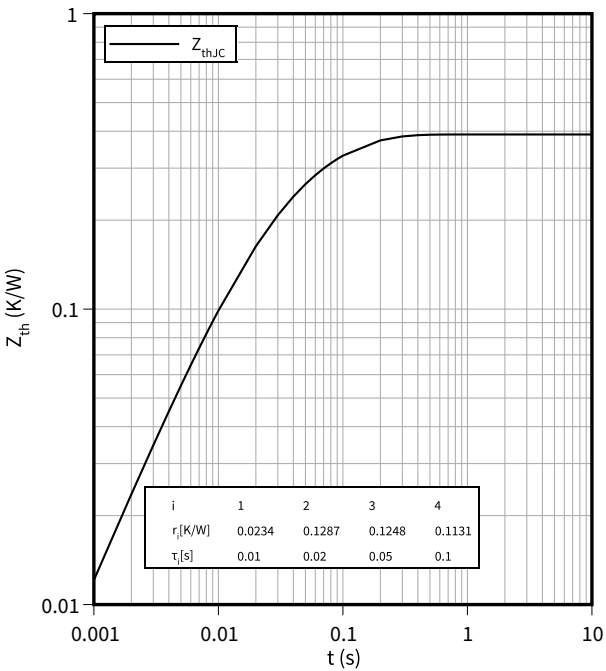
$I_C = f(V_{CE})$

$R_{Goff} = 1.1 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $T_{vj} = 150 \text{ °C}$



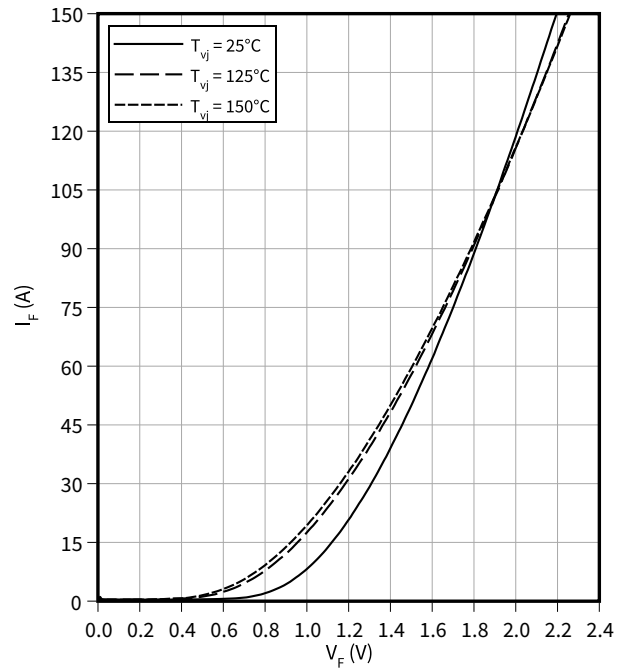
Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$



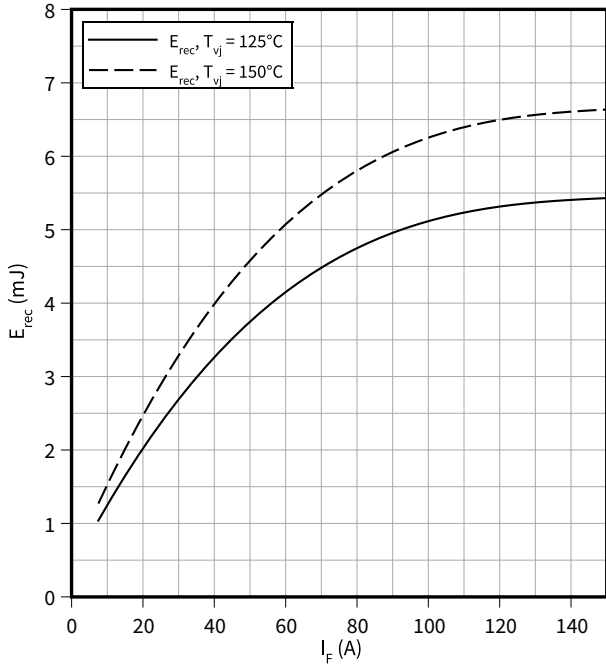
Forward characteristic (typical), Diode, Inverter

$I_F = f(V_F)$



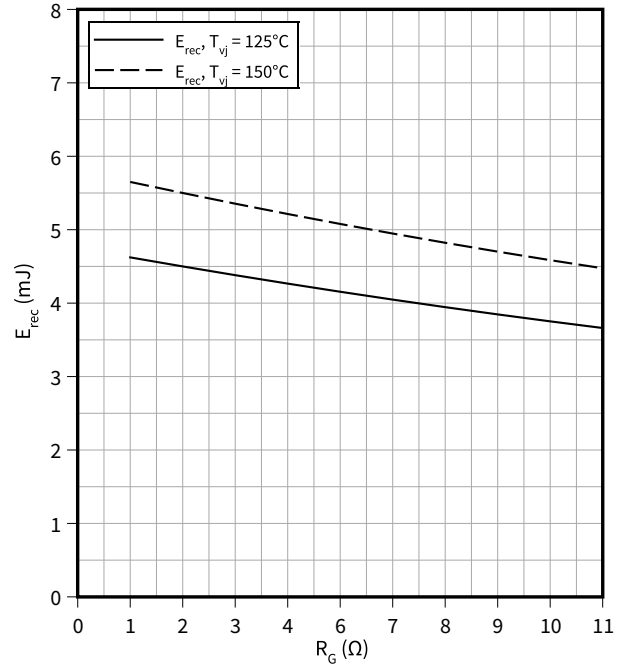
Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$
 $R_{Gon} = 1.1 \Omega, V_{CC} = 600 V$



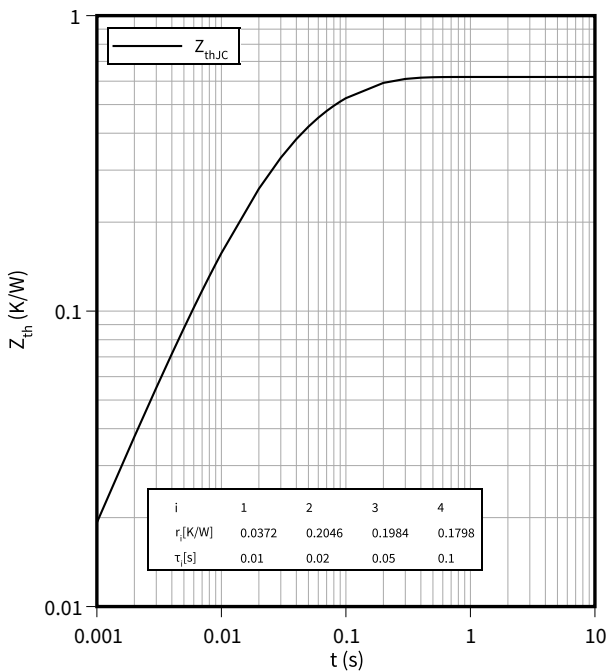
Switching losses (typical), Diode, Inverter

$E_{rec} = f(R_G)$
 $I_F = 75 A, V_{CC} = 600 V$



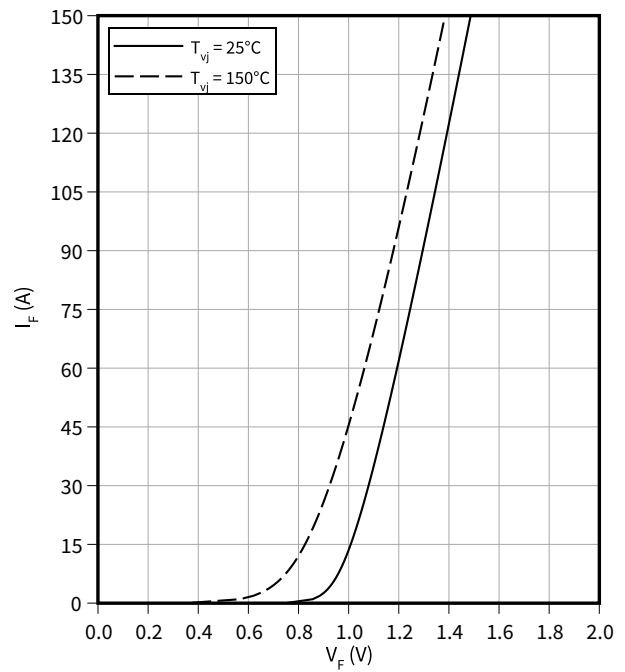
Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Rectifier

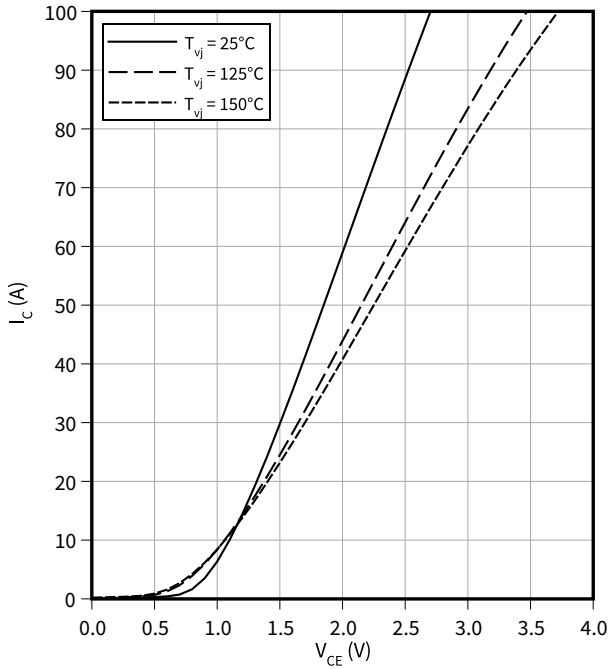
$I_F = f(V_F)$



Output characteristic (typical), IGBT, Brake-Chopper

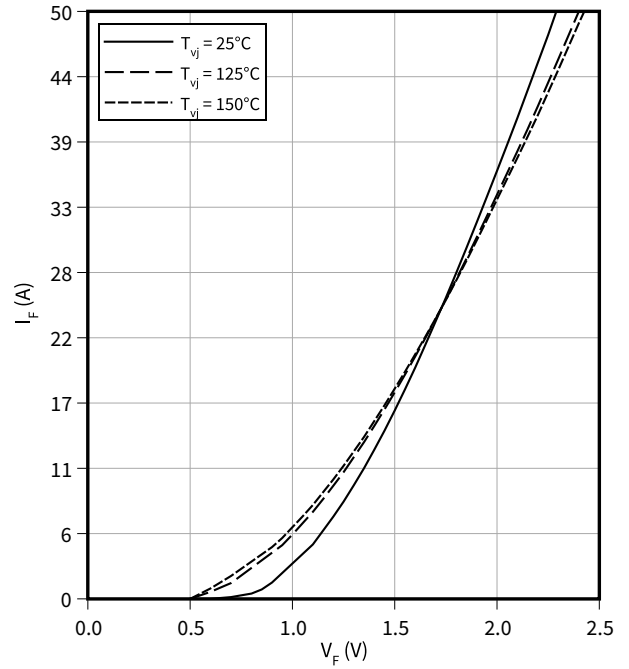
$I_C = f(V_{CE})$

$V_{GE} = 15\text{ V}$



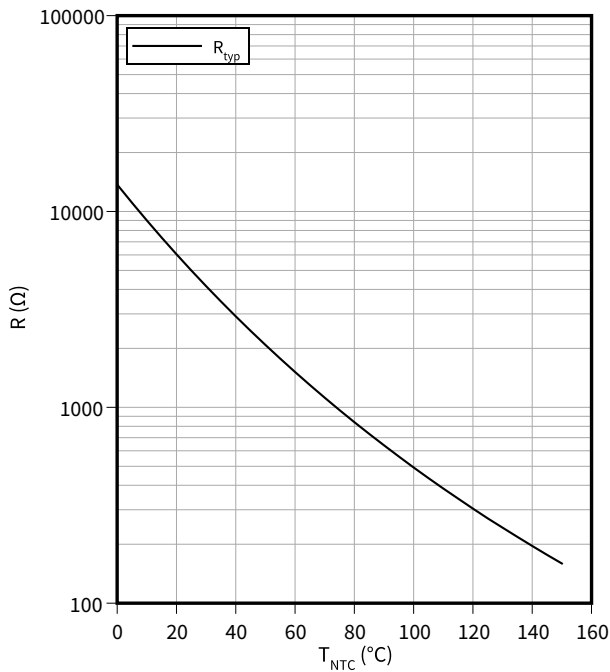
Forward characteristic (typical), Diode, Brake-Chopper

$I_F = f(V_F)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



9 Circuit diagram

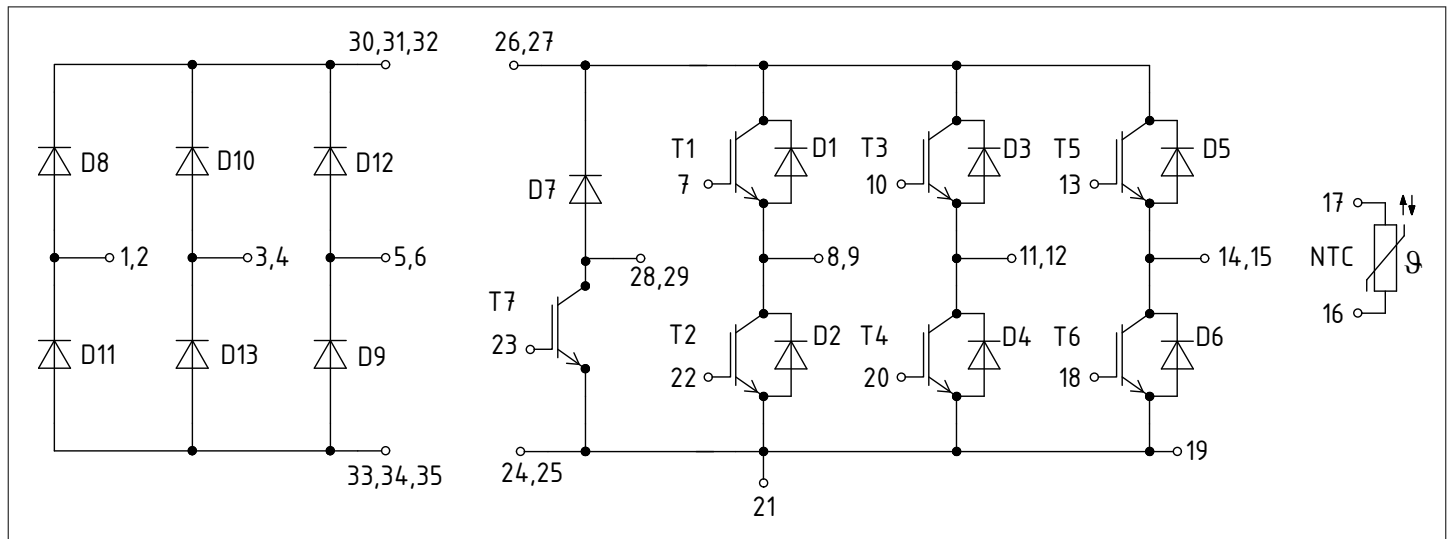


Figure 1

10 Package outlines

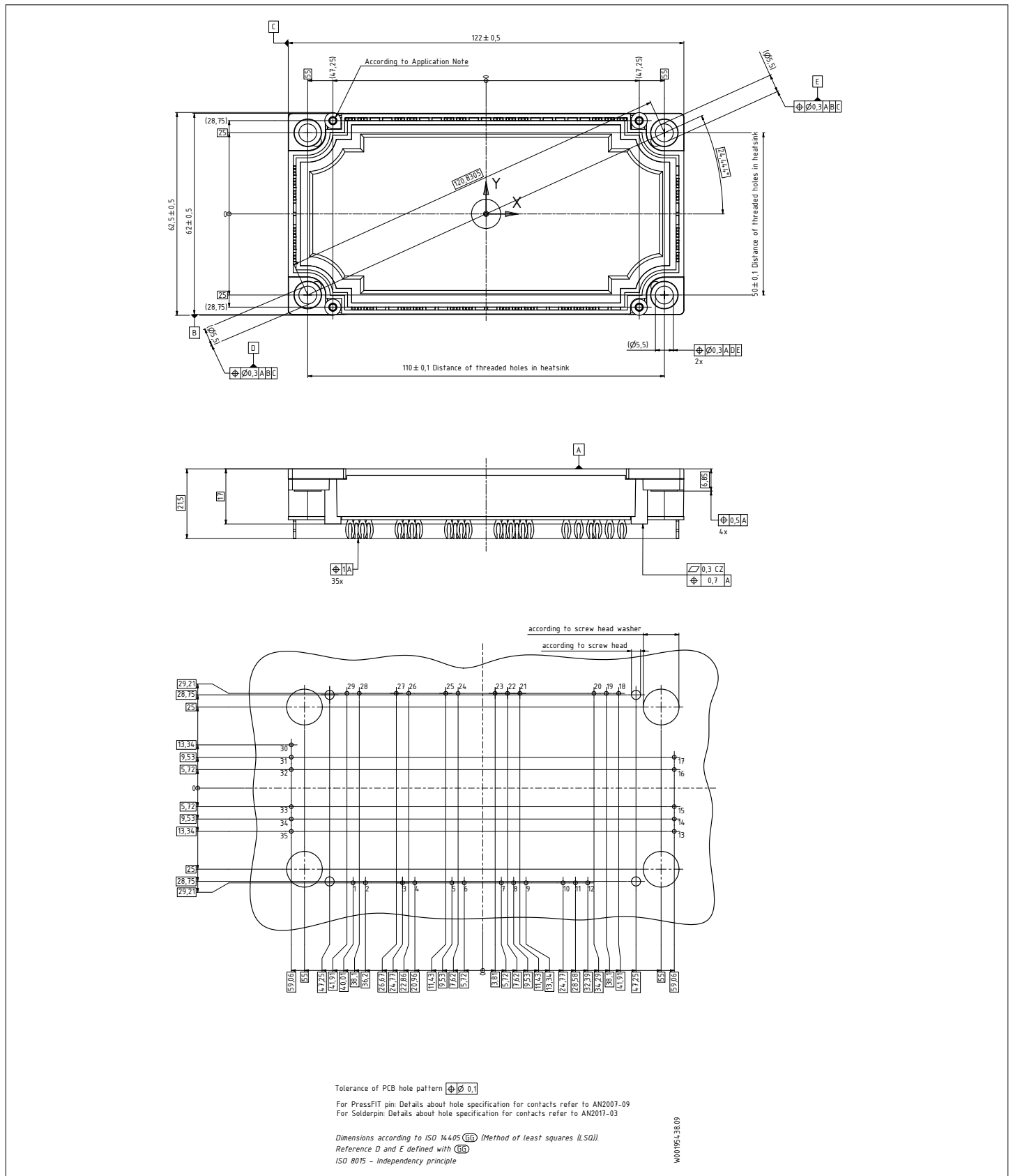


Figure 2

11 Module label code


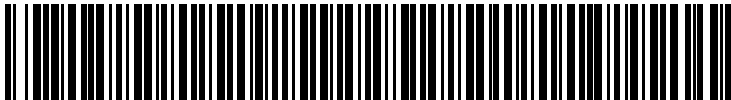
Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 - 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 - 21	15
	Date code (production week)	22 - 23	30
Example	 		
	71549142846550549911530		71549142846550549911530

Figure 3

Revision history

Document revision	Date of release	Description of changes
V1.0	2006-04-28	Target datasheet
V1.1	2006-05-29	Target datasheet
V1.2	2006-06-08	Target datasheet
V1.3	2006-11-13	Target datasheet
V2.0	2007-10-31	Preliminary datasheet
V2.1	2007-11-23	Preliminary datasheet
V2.2	2008-12-02	Preliminary datasheet
V3.0	2010-04-29	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2023-11-24	Final datasheet

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